Power Splitter/Combiner

ADP-2-1W-28+

2 Way-0°

 50Ω

1 to 700 MHz

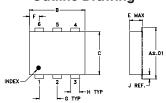
Maximum Ratings

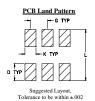
Operating Temperature	-40°C to 85°C						
Storage Temperature	-55°C to 100°C						
Power Input (as a splitter)	2W max.						
Internal Dissipation	0.125W max.						
Permanent damage may occur if any of these limits are exceeded.							

Pin Connections

SUM PORT	1
PORT 1	3
PORT 2	4
GROUND	6
NOT USED	2,5

Outline Drawing

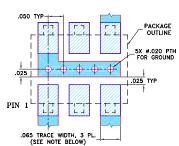




Outline Dimensions (inch)

G	F	Е	D	С	В	Α	
.100	.055	.162	.100	.220	.310	.272	
2.54	1.40	4.11	2.54	5.59	7.87	6.91	
wt			L	K	J	Н	
grams			.300	.065	.026	.030	
0.25			7.62	1.65	0.66	0.76	

Demo Board MCL P/N: TB-48+ Suggested PCB Layout (PL-035)



.065 TRACE WIDTH, 3 PL.
.(SEE NOTE BELOW)

NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC
THICKNESS .030" ± .002"; COPPER: 1/2 02. Each SIDE.
FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC
(SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Features

- low insertion loss, 0.25 dB typ.
- excellent amplitude unbalance, 0.01 dB typ.
- very good phase unbalance, 0.2 deg. typ.
- aqueous washable
- protected under U.S. Patent 6,133,525

Applications

VHF/UHF receivers/transmitters

Generic photo used for illustration purposes only

CASE STYLE: CD636

+RoHS Compliant The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications



Electrical Specifications

FREQ. RANGE (MHz)	ISOLATION (dB)			TION LOS BOVE 3.0 o		UNI	PHASI BALAI Degree	NCE	AMPLITUDE UNBALANCE (dB)			
	L	M	U	L	M	U	L	М	U	L	M	U
f _L -f _U	Typ. Min.	Typ. Min.	Typ. Min.	Тур. Мах.	Тур. Мах.	Тур. Мах.	Max.	Max.	Max.	Max.	Max.	Max.
1-700	30 20	30 20	24 20	0.2 0.8	0.25 0.8	0.5 1.0	2.0	2.0	3.0	0.15	0.2	0.3

L = 1-10 MHz M = 10-325 MHz U = 325-700 MHz

electrical schematic



A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.

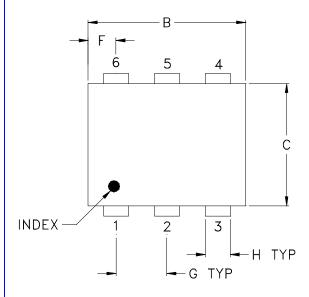
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

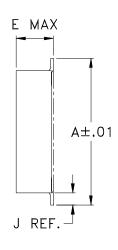
Case Style

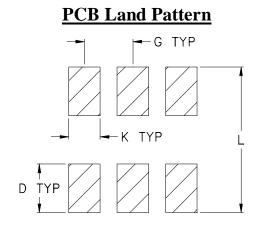
CD

Outline Dimensions

CD541 CD542 CD636 CD637







Suggested Layout, Tolerance to be within ±.002

CASE#	A	В	С	D	Е	F	G	Н	J	K	L	WT, GRAM
CD541					.082 (2.08)							.15
CD542	.272	.310	.220	.100	.112 (2.84)	.055	.100	.030	.026	.065	.300	.20
CD636	(6.91)	(7.87)	(5.58)	(2.54)	.162 (4.11)	(1.40)	(2.54)	(0.76)	(0.66)	(1.65)	(7.62)	.25
CD637					.206 (5.23)							.40

Dimensions are in inches (mm). Tolerances: 2 Pl. \pm .01; 3 Pl. \pm .005

Notes:

1. Case material: Plastic.

2. Termination finish:

For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.

For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



INTERNET http://www.minicircuits.com

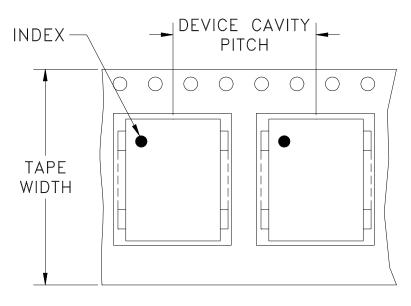
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Mini-Circuits ISO 9001 & ISO 14001 Certified

Tape & Reel Packaging TR-F34

DEVICE ORIENTATION IN T&R



DIRECTION OF FEED

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	per Reel note	
16	12	7	Small quantity standard (see note)	20 50 100 200
		13	Standard	500 1000

Note: Availability of small reel quantity varies by model.

Refer to pricing and availability on individual model dashboard.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

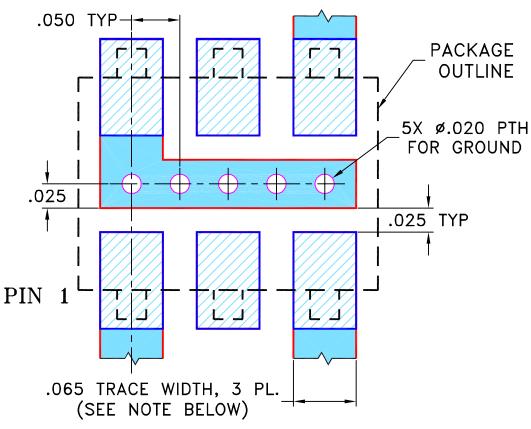
Go to: www.minicircuits.com/pages/pdfs/tape.pdf



THIRD ANG	LE PROJECTION
\triangle	

		REVISIONS			
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M77049	NEW RELEASE	05/01	ΑV	CT
A	M82377	UPDATED DRAWING	07/31/02	ΑV	HY
В	M82846	UPDATED DRAWING	05/13/03	MMG	HY
C	M102713	ADDED BK292 CASE STYLE & "WITH SMOBC"	01/17/06	MMG	IL

SUGGESTED MOUNTING CONFIGURATION FOR BK292/CD542/CD636 CASE STYLES, "hv" PIN CONNECTION



NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .030" \pm .002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.

2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE			1 3 6 .		. •	• 4 ®			
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TOLERANCES ON: 2 PL DECIMALS ±	CHECKED	DY	06/11/01							orookiyn	N1 114	200
3 PL DECIMALS ± .005	APPROVED	CT	06/11/01	1								
FRACTIONS ±] PL.	h	v, BK292	2/CD5	42/CD63	6. ADP	/JPS	. TB	-48
☐ Mini-	-Circuits ®],		,	,	,	-,	,	,	-
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	ASHEETA1.D	WE KEY:A DA	TE:01/12/95								<u> </u>	_



Environmental Specifications

ENV02T1

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215

ENV02T1 Rev: B

02/25/11

M130240 File: ENV02T1.pdf

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